VS-ST180SPbF Series

Vishay Semiconductors

Phase Control Thyristors (Stud Version), 200 A



PRIMARY CHARACTERISTICS					
I _{T(AV)} 200 A					
V _{DRM} /V _{RRM}	1600 V, 2000 V				
V _{TM}	1.75 V				
I _{GT}	150 mA				
TJ	-40 °C to +125 °C				
Package	TO-93 (TO-209AB)				
Circuit configuration	Single SCR				

FEATURES

- Center amplifying gate
- International standard case TO-93 (TO-209AB))
- Hermetic metal case with ceramic insulator
- Compression bonded encapsulation for heavy duty operations such as severe thermal cycling
- Designed and qualified for industrial level
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

- DC motor controls
- Controlled DC power supplies
- AC controllers

MAJOR RATINGS AND CHARACTERISTICS						
PARAMETER	TEST CONDITIONS	VALUES	UNITS			
1		200	A			
I _{T(AV)}	T _C	85	°C			
I _{T(RMS)}		314	A			
50 Hz		5000				
ITSM	60 Hz	5230	— A			
50 Hz		125	1.42-			
l ² t	60 Hz	114	— kA ² s			
V _{DRM} /V _{RRM}		1600 to 2000	V			
tq	Typical	100	μs			
TJ		-40 to +125	°C			

ELECTRICAL SPECIFICATIONS

VOLTAGE RATINGS							
TYPE NUMBER	VOLTAGE CODE	V _{DRM} /V _{RRM} , MAXIMUM REPETITIVE PEAK AND OFF-STATE VOLTAGE V	V _{RSM} , MAXIMUM NON-REPETITIVE PEAK VOLTAGE V	$I_{DRM}/I_{RRM} MAXIMUM$ AT T _J = T _J MAXIMUM mA			
VS-ST180S	16	1600	1700	30			
v3-311003	20	2000	2100				

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COMPLIANT

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ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL		TEST CON	DITIONS	VALUES	UNITS
Maximum average on-state current	I _{T(AV)}	180° condu	180° conduction, half sine wave			A °C
at case temperature					85	-0
Maximum RMS on-state current	I _{T(RMS)}	DC at 76 °C	case temperat	ure	314	
		t = 10 ms	No voltage		5000	
Maximum peak, one-cycle		t = 8.3 ms	reapplied		5230	А
non-repetitive surge current	I _{TSM}	t = 10 ms	100 % V _{RRM}		4200	- kA ² s
		t = 8.3 ms	reapplied	Sinusoidal half wave,	4400	
Marine 124 for function	l ² t	t = 10 ms	No voltage	initial $T_J = T_J$ maximum	125	
		t = 8.3 ms	reapplied		114	
Maximum I ² t for fusing	1-1	t = 10 ms	100 % V _{RRM}		88	
		t = 8.3 ms reapplied			81	
Maximum I ² √t for fusing	l²√t	t = 0.1 to 10) ms, no voltage	reapplied	1250	kA²√s
Low level value of threshold voltage	V _{T(TO)1}	(16.7 % x π	$x I_{T(AV)} < I < \pi x$	I _{T(AV)}), T _J = T _J maximum	1.08	v
High level value of threshold voltage	V _{T(TO)2}	$(I > \pi \times I_{T(AV)}), T_J = T_J maximum$			1.14	v
Low level value of on-state slope resistance	r _{t1}	(16.7 % x π x I _{T(AV)} < I < π x I _{T(AV)}), T _J = T _J maximum			1.18	
High level value of on-state slope resistance	r _{t2}	$(I > \pi \times I_{T(AV)}), T_J = T_J maximum$ 1.1			1.14	mΩ
Maximum on-state voltage	V _{TM}	$I_{pk} = 570 \text{ A}, T_{J} = 125 \text{ °C}, t_{p} = 10 \text{ ms sine pulse}$			1.75	V
Maximum holding current	Ι _Η	T _ T _ may	imum anada a	upply 12 V registive lead	600	mA
Maximum (typical) latching current	١L	ij=ijmax	linum, anode st	upply 12 V resistive load	1000 (300)	ma

SWITCHING				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum non-repetitive rate of rise of	dl/dt	Gate drive 20 V, 20 $\Omega,t_r \leq 1~\mu s$	1000	A∕µs
turned-on current	u/u	T_J = T_J maximum, anode voltage $\leq 80~\%~V_{DRM}$	1000	rvμs
Typical delay time	+	Gate current 1 A, dl _g /dt = 1 A/µs	1.0	
Typical delay time t _d		$V_d = 0.67 \% V_{DRM}, T_J = 25 \ ^{\circ}C$	1.0	
Typical turn-off time t _q		$\begin{split} I_{TM} &= 300 \text{ A}, T_J = T_J \text{ maximum, dI/dt} = 20 \text{ A/}\mu\text{s}, \\ V_R &= 50 \text{ V}, \text{ dV/dt} = 20 \text{ V/}\mu\text{s}, \text{ gate } 0 \text{ V} 100 \ \Omega, t_p = 500 \ \mu\text{s} \end{split}$	100	μs

BLOCKING				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum critical rate of rise of off-state voltage	dV/dt	$T_J = T_J$ maximum linear to 80 % rated V_{DRM}	500	V/µs
Maximum peak reverse and off-state leakage current	I_{RRM} , I_{DRM} $T_{J} = T_{J}$ maximum, rated V_{DRM}/V_{RRM} applied		30	mA





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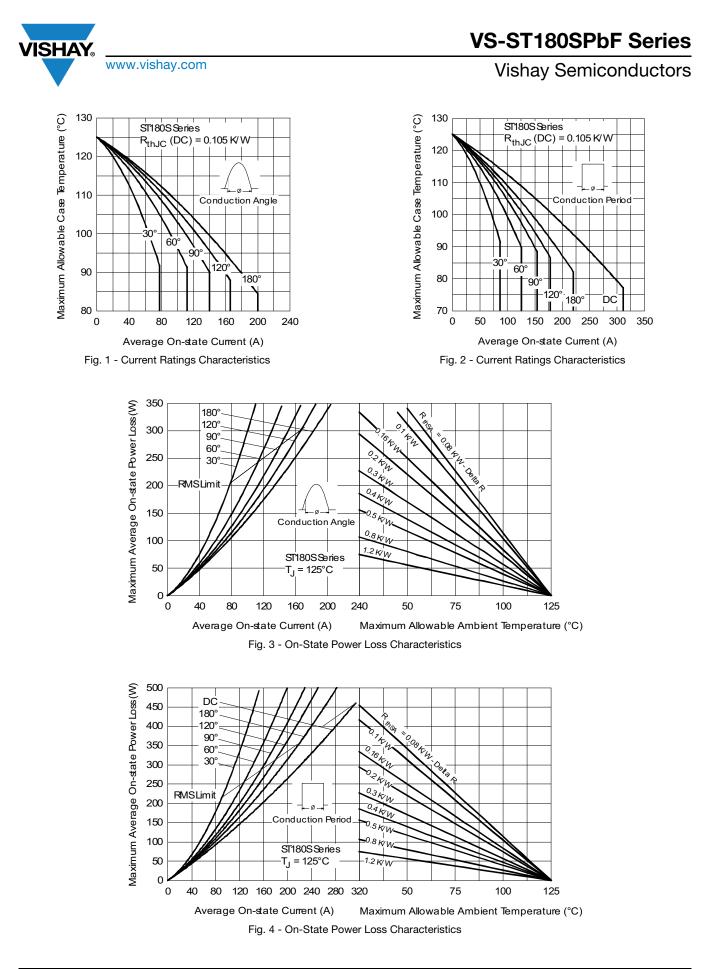
TRIGGERING						
PABAMETER	SYMBOL	т	EST CONDITIONS	VALUES		UNITS
FANAMETEN	STMBOL	•	EST CONDITIONS	TYP.	MAX.	UNITS
Maximum peak gate power	P _{GM}	$T_J = T_J$ maximum,	$t_p \le 5 \text{ ms}$	1	0	W
Maximum average gate power	P _{G(AV)}	$T_J = T_J$ maximum,	f = 50 Hz, d% = 50	2	.0	vv
Maximum peak positive gate current	I _{GM}	T _J = T _J maximum,	t _p ≤ 5 ms	3	.0	А
Maximum peak positive gate voltage	+ V _{GM}		t < 5 mc	2	0	V
Maximum peak negative gate voltage	- V _{GM}	ij = ij maximum,	$T_J = T_J$ maximum, $t_p \le 5$ ms 5.0		.0	v
	I _{GT}	$T_J = -40 \ ^\circ C$		180	-	mA
DC gate current required to trigger		T _J = 25 °C	Maximum required gate trigger/	90	150	
		T _J = 125 °C	current/voltage are the lowest	40	-	
		$T_J = -40 \ ^\circ C$	value which will trigger all units	2.9	-	
DC gate voltage required to trigger	V _{GT}	T _J = 25 °C	12 V anode to cathode applied	1.8	3.0	V
		T _J = 125 °C		1.2	-	1
DC gate current not to trigger	I _{GD}		Maximum gate current/voltage	10		mA
DC gate voltage not to trigger	V _{GD}	$T_J = T_J maximum$	not to trigger is the maximum value which will not trigger any unit with rated V _{DRM} anode to cathode applied	0.25		V

THERMAL AND MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Maximum operating junction temperature range	TJ		-40 to +125	°C		
Maximum storage temperature range	T _{Stg}		-40 to +150			
Maximum thermal resistance, junction to case	R _{thJC}	DC operation 0.105		K/W		
Maximum thermal resistance, case to heatsink	R _{thC-hs}	Mounting surface, smooth, flat and greased 0.0		r∨ vv		
Mounting torque, ± 10 %		Non-lubricated threads	31 (275)	N·m		
Nounting torque, ± 10 %		Lubricated threads	24.5 (210)	(lbf · in)		
Approximate weight			280	g		
Case style		See dimensions - link at the end of datasheeet	TO-93 (TO-20	09AB)		

$\Delta \mathbf{R}_{thJC}$ CONDUCTION				
CONDUCTION ANGLE	SINUSOIDAL CONDUCTION	RECTANGULAR CONDUCTION	TEST CONDITIONS	UNITS
180°	0.015	0.012		
120°	0.019	0.020		
90°	0.025	0.027	T _J = T _J maximum	K/W
60°	0.036	0.037		
30°	0.060	0.060		

Note

The table above shows the increment of thermal resistance R_{thJC} when devices operate at different conduction angles than DC



### **Vishay Semiconductors**



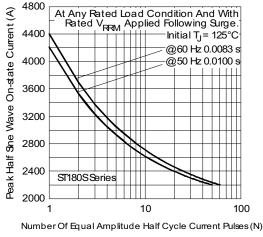
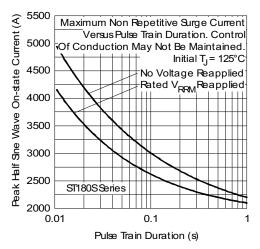
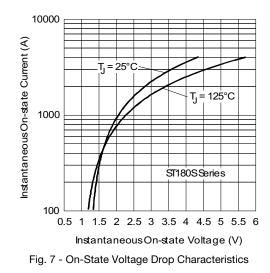
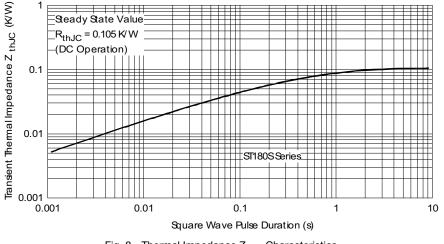


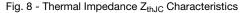
Fig. 5 - Maximum Non-Repetitive Surge Current





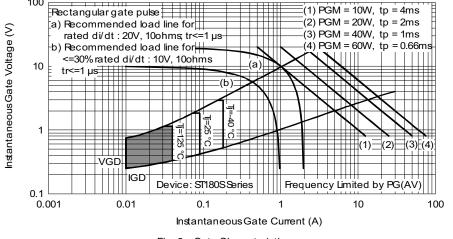






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# Www.vishay.com VS-ST180SPbF Series Vishay Semiconductors



### Fig. 9 - Gate Characteristics

### **ORDERING INFORMATION TABLE**

Device code	VS-	ST	18	0	S	20	Р	0	PbF
	1	2	3	4	5	6	7	8	9
	<ol> <li>Vishay Semiconductors product</li> <li>Thyristor</li> </ol>								
	3 -	Ess	ential p	art num					
	4 - 5 -			er grade ession bo		tud			
	6 - 7 -		-	de x 100 ise 3/4"-			-	Ratings	table)
	8 -			erminals					
	9 -	Nor	ne = sta	terminal ndard pr (Pb)-fre	oductio		iliary ca	athode I	eads)

Note: For metric device M16 x 1.5 contact factory

LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95082			

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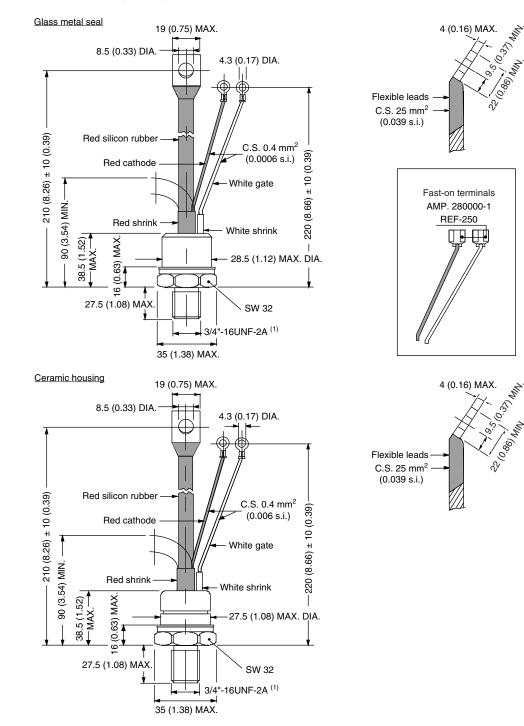
NI.

NIN,



### **DIMENSIONS** in millimeters (inches)

www.vishay.com



#### Note

⁽¹⁾ For metric device: M16 x 1.5 - length 21 (0.83) maximum

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